TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (Ultra-High-Speed U-MOSIII)

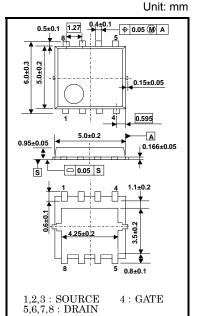
TPCA8020-H

High-Efficiency DC / DC Converter Applications
Notebook PC Applications
Portable Equipment Applications
CCFL Inverter Applications

- Small footprint due to a small and thin package
- High speed switching
- Small gate charge: Qsw = 3.5 nC (typ.)
- Low drain-source ON-resistance: $RDS(ON) = 22 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: $|Y_{fs}| = 15 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 10 \mu A \text{ (max) (V}_{DS} = 40 \text{ V)}$
- Enhancement mode: $V_{th} = 1.1 \text{ to } 2.3 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$

Absolute Maximum Ratings (Ta = 25°C)

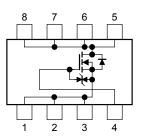
Characteristic			Symbol	Rating	Unit
Drain-source voltage			V_{DSS}	40	V
Drain-gate voltage (R_{GS} = 20 k Ω)			V_{DGR}	40	V
Gate-source volt	age		V _{GSS}	±20	V
Drain current	DC	(Note 1)	I _D	7.5	Α
Diain current	Pulse	(Note 1)	I_{DP}	30	A
Drain power dissipation (Tc=25°C)			P _D	30	W
Drain power diss (t = 10 s)	ipation	(Note 2a)	P_{D}	2.8	W
Drain power dissipation (t = 10 s) (Note 2b)			P _D	1.6	W
Single-pulse avalanche energy (Note 3)			E _{AS}	26	mJ
Avalanche curre	nt		I _{AR}	7.5	Α
Repetitive avalanche energy Single-device value at dual operation (Note 2a, 4)			Ear	1.9	mJ
Channel temperature			T _{ch}	150	°C
Storage temperature range			T _{stg}	-55 to 150	°C



Weight: 0.066 g (typ.)

JEDEC JEITA TOSHIBA

Circuit Configuration



2-5Q1A

Note: For Notes 1 to 4, refer to the next page.

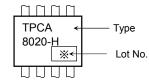
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

This transistor is an electrostatic-sensitive device. Handle with care.

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case (Tc=25°C)	R _{th (ch-c)}	4.17	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	78.1	°C/W

Marking (Note 5)

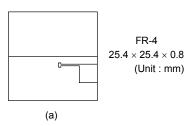


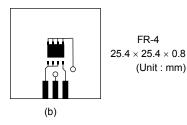
Note 1: The channel temperature should not exceed 150°C during use.

Note 2:

a) Device mounted on a glass-epoxy board (a)

b) Device mounted on a glass-epoxy board (b)

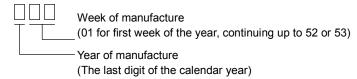




Note 3: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 0.5 mH, R_G = 25 Ω , I_{AR} = 7.5 A

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: * Weekly code: (Three digits)

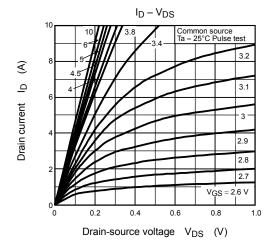


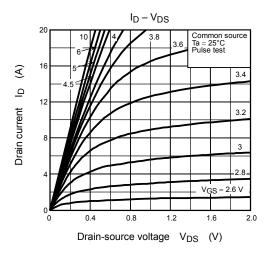
Electrical Characteristics (Ta = 25°C)

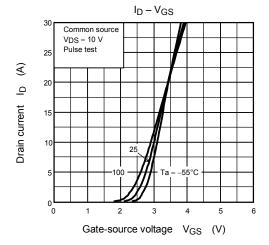
Chara	Characteristic		Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μА
Drain cutoff curr	ent	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V	_	_	10	μА
Drain-course br	Orain-source breakdown voltage		I _D = 10 mA, V _{GS} = 0 V	40	_	_	V
Diain-source bi	eakuowii voitage	V _{(BR) DSX}	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$ 25 — $V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$ 1.1 —		_	V	
Gate threshold v	/oltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	1.1	_	2.3	V
Drain-source O	Drain-source ON-resistance		V _{GS} = 4.5 V, I _D = 3.8 A	_	27	35	mΩ
Dialii Source O	IN-TESISTATICE	R _{DS} (ON)	V _{GS} = 10 V, I _D = 3.8 A	— 22 27 7.5 15 —		27	
Forward transfe	rward transfer admittance		V _{DS} = 10 V, I _D = 3.8 A	7.5	15	_	S
Input capacitano	Input capacitance			_	650	_	
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	55	_	pF
Output capacitance		C _{oss}		_	240	_	
Switching time	Rise time	tr	V_{GS} 10 V $I_{D} = 3.8 \text{ A}$ 0 V 0 V 0 C $0 $	_	3	_	- ns
	Turn-on time	t _{on}		_	9		
	Fall time	t _f		_	2	_	
	Turn-off time	t _{off}	Duty ≦ 1%, t _W = 10 μs	_	18	_	
Total gate charg	je	0	$V_{DD} \simeq 32 \ V_{\bullet} \ V_{GS} = 10 \ V_{\bullet} \ I_D = 7.5 \ A$	D = 7.5 A — 11		_	
(gate-source plu	us gate-drain)	Q_g	$V_{DD} \simeq 32 \; V \text{, } \; V_{GS} = 5 \; V \text{, } \; I_D = 7.5 \; A$	_	6.2 —		
Gate-source charge		Q _{gs1}	$V_{DD} \simeq 32 \ V_{\text{v}} \ V_{GS} = 10 \ V_{\text{v}} \ I_D = 7.5 \ A$	_	2.1	_	nC
Gate-drain ("Miller") charge		Q _{gd}		_	2.7	_	-
Gate switching charge		Q _{sw}		_	3.5	_	

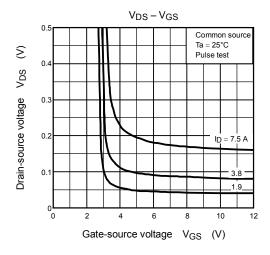
Source-Drain Ratings and Characteristics (Ta = 25°C)

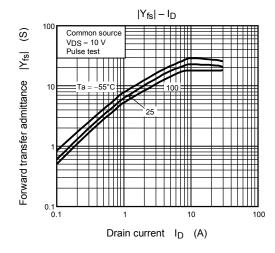
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	_	_	_	30	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 7.5 A, V _{GS} = 0 V	_	_	-1.2	V

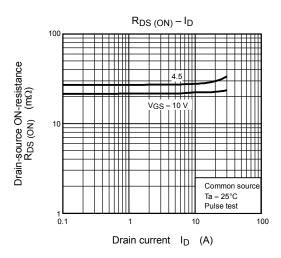


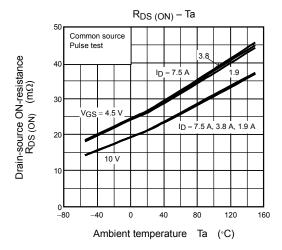


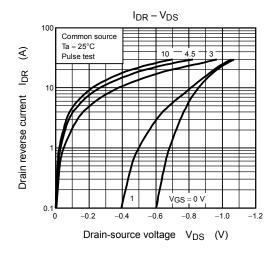


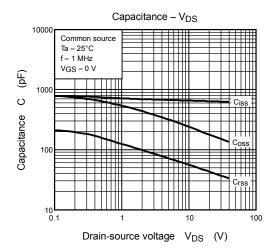


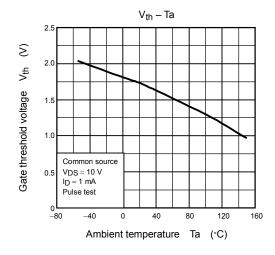


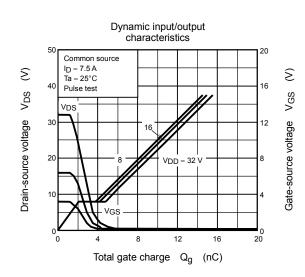


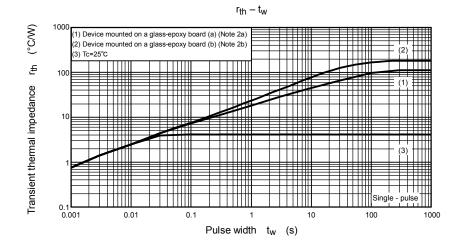


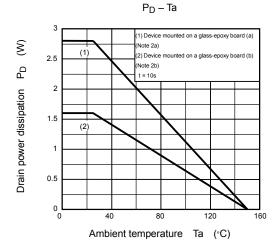


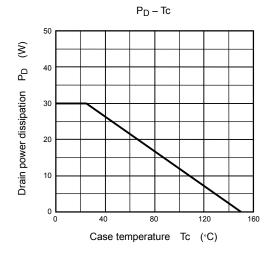


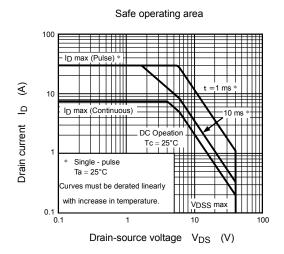












RESTRICTIONS ON PRODUCT USE

060116EAA

- The information contained herein is subject to change without notice. 021023_D
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
 In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc. 021023_A
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk. 021023_B
- The products described in this document shall not be used or embedded to any downstream products of which
 manufacture, use and/or sale are prohibited under any applicable laws and regulations. 060106_Q
- The information contained herein is presented only as a guide for the applications of our products. No responsibility
 is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from
 its use. No license is granted by implication or otherwise under any patent or patent rights of TOSHIBA or others.
 021023_C